

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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### 1. Scope

The present specifications shall apply to an FMB-29.

### 2. Outline

Туре	Silicon Schottky Barrier Diode		
Structure	Resin Molded		
Applications	High Frequency Rectification		

## 3. Flammability

UL94V-0(Equivalent)

#### 4. Absolute maximum ratings

No.	Item	Symbol	Unit	Rating	Conditions
1	Transient Peak Reverse Voltage	$V_{RSM}$	V	90	
2	Peak Reverse Voltage	$V_{RM}$	V	90	
3	Average Forward Current	I <sub>F(AV)</sub>	A	4.0	Refer to Derating of 7
4	Peak Surge Forward Current	$I_{FSM}$	A	50	10msec. Half sinewave, one shot
5	I <sup>2</sup> t Limiting Value	$I^2t$	$A^2s$	12.5	1msec≤t≤10msec
6	Junction Temperature	$T_j$	°C	-40~+150	
7	Storage Temperature	$T_{stg}$	°C	-40~+150	

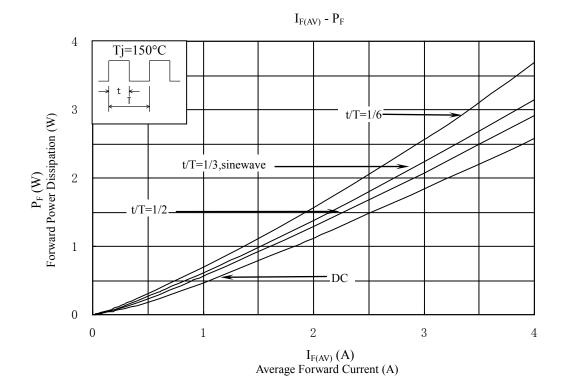
No.1,2,4&5 show ratings per one chip.

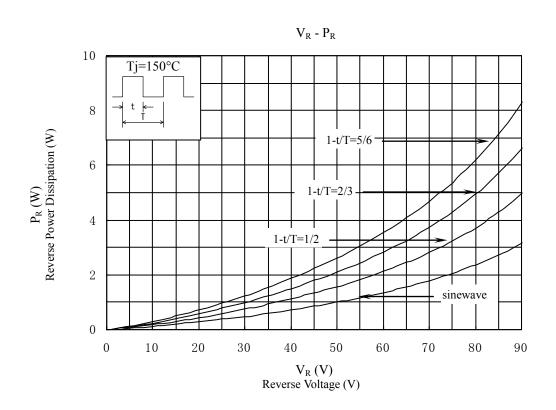
# 5. Electrical characteristics (Ta=25°C , unless otherwise specified)

No ·	Item	Symbol	Unit	Value	Conditions
1	Forward Voltage Drop	$V_{\rm F}$	V	0.81 max.	I <sub>F</sub> =2.0A
2	Reverse Leakage Current	$I_R$	mA	3.0 max.	$V_R = V_{RM}$
3 Reverse Leakage Current Und High Temperature	Reverse Leakage Current Under	11.1	m A	15 max.	$V_R = V_{RM}, T_j = 125$ °C
	$H \cdot I_R$	mA	55 max.	$V_R = V_{RM}, T_j = 150^{\circ}C$	
4	Thermal Resistance	$R_{\text{th(j-c)}}$	°C/W	4.0 max.	Between Junction and case

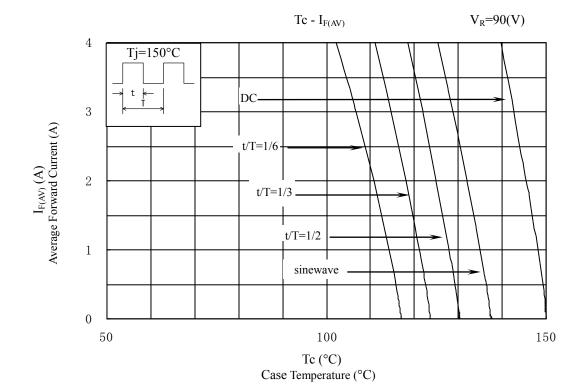
No.1,2,&3 show characteristics per one chip.

### 6. Characteristics





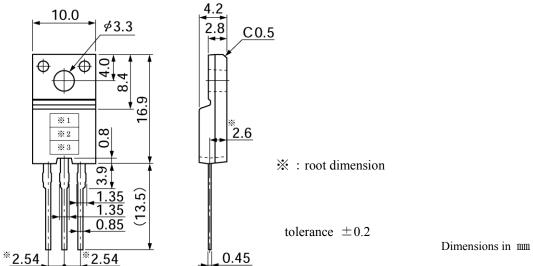
## 7. Derating



040512

### 8. Package information

8-1 Package type, physical dimensions and material



### 8-2 Appearance

The body shall be clean and shall not bear any stain, rust or flaw.

8-3 Marking

Warking	Marking				
Type Name	* 1 Type Name	* 2 Polarity	*3 Lot number		
FMB-29	FMB29		1st letter: Last digit of year  2nd letter: Month From 1 to 9 for Jan. to Sep., O for Oct., N for Nov., D for Dec.  3rd & 4th letter: Day ex. 4512 (May.12, 2004)		